

## Rail-to-rail 1.8V high-speed comparator

### Features

- Propagation delay: 33ns
- Low current consumption: 64 $\mu$ A
- Rail-to-rail inputs
- Push-pull outputs
- Supply operation from 1.8V to 5V
- Wide temperature range: -40°C to +125°C
- ESD tolerance: 2kV HBM / 200V MM
- Latch-up immunity: 200mA
- SMD packages

### Applications

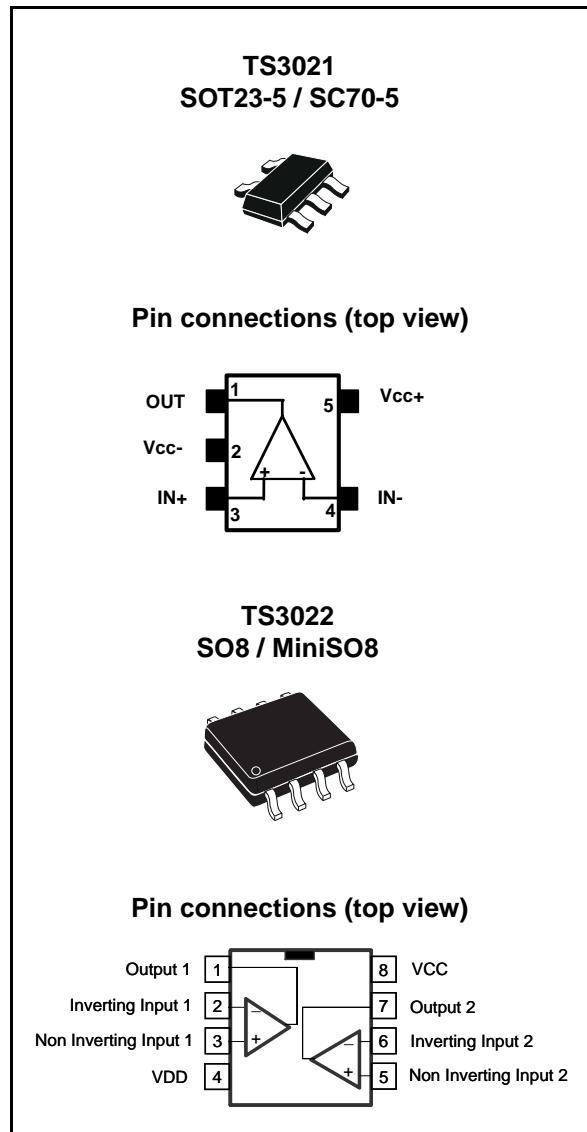
- Telecom
- Instrumentation
- Signal conditioning
- High-speed sampling systems
- Portable communication systems

### Description

The TS3021/2 single and dual comparators feature high-speed response time with rail-to-rail inputs. Specified from 2V to 5V supply voltage, these comparators can operate over a wide temperature range: -40°C to +125°C.

The TS3021/2 comparators offer micropower consumption as low as a few tens of microamperes thus providing an excellent ratio of power consumption current versus response time.

The TS3021/2 include push-pull outputs and are available in small packages (SMD).



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# 1 Absolute maximum ratings and operating conditions

**Table 1. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply voltage <sup>(1)</sup>	5.5	V
$V_{ID}$	Differential input voltage <sup>(2)</sup>	$\pm 5$	V
$V_{IN}$	Input voltage range	$V_{DD}-0.3$ to $V_{CC}+0.3$	V
$P_D$	Power dissipation <sup>(3)</sup> SC70-5 SOT23-5 SO8 MiniSO8	260 500 1000 650	mW
$T_{stg}$	Storage temperature	-65 to +150	°C
$T_j$	Junction temperature	150	°C
$T_{LEAD}$	Lead temperature (soldering 10 seconds)	260	°C
ESD <sup>(4)</sup>	Human body model (HBM)	2000	V
	Machine model (MM)	200	
	Latch-up immunity	200	mA

1. All voltage values, except differential voltage, are referenced to  $V_{DD}$ .
2. The magnitude of input and output voltages must never exceed the supply rail  $\pm 0.3V$ .
3. Short-circuits can cause excessive heating and destructive dissipation.  $P_D$  is calculated with  $T_{amb}=+25^\circ C$ ,  $T_j=+150^\circ C$  and  $R_{thja} = 478^\circ C/W$  for SC70-5,  $R_{thja} = 250^\circ C/W$  for SOT23-5,  $R_{thja} = 125^\circ C/W$  for SO8,  $R_{thja} = 190^\circ C/W$  for MiniSO8.
4. ESD tolerances are compliant with MIL883C, JEDEC STANDARD JESD22, ANSI/ESD STM5.1-2001.

**Table 2. Operating conditions**

Symbol	Parameter	Value	Unit
$T_{amb}$	Ambient temperature	-40 to +125	°C
$V_{CC}$	Supply voltage $0^\circ C < T_{amb} < +125^\circ C$ $-40^\circ C < T_{amb} < +125^\circ C$	1.8 to 5 2 to 5	V
$V_{icm}$	Common mode input voltage range $-40^\circ C < T_{amb} < +85^\circ C$ $+85^\circ C < T_{amb} < +125^\circ C$	$V_{DD}-0.2$ to $V_{CC}+0.2$ $V_{DD}$ to $V_{CC}$	V
$R_{thja}$ <sup>(1)</sup>	Thermal resistance junction to ambient SC70-5 SOT23-5 SO8 MiniSO8	478 250 125 190	°C/W

1. For a 4-layer PCB.

## 2 Electrical characteristics

**Table 3.  $V_{CC}=+2V$ ,  $T_{amb} = +25^{\circ}C$ , full  $V_{icm}$  range (unless otherwise specified)<sup>(1)</sup>**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{IO}$	Input offset voltage	$-40^{\circ}C < T_{amb} < +125^{\circ}C$	-	0.5	8 10	mV
$\Delta V_{IO}$	Input offset voltage drift	$-40^{\circ}C < T_{amb} < +125^{\circ}C$	-	3	20	$\mu V/^{\circ}C$
$I_{IO}$	Input offset current <sup>(2)</sup>	$-40^{\circ}C < T_{amb} < +125^{\circ}C$	-	1	20 100	nA
$I_{IB}$	Input bias current <sup>(2)</sup>	$-40^{\circ}C < T_{amb} < +125^{\circ}C$	-	80	160 300	nA
$I_{CC}$	Supply current	No load, output low, $V_{icm}=0V$ $-40^{\circ}C < T_{amb} < +125^{\circ}C$ No load, output high, $V_{icm}=0V$ $-40^{\circ}C < T_{amb} < +125^{\circ}C$	-	75 64	105 90 115 125	$\mu A$
$I_{SC}$	Short-circuit current	Source Sink	-	12 13	-	mA
$V_{OH}$	Output voltage high	$I_{source}=1mA$ $-40^{\circ}C < T_{amb} < +125^{\circ}C$	1.88 1.80	1.94	-	V
$V_{OL}$	Output voltage low	$I_{source}=1mA$ $-40^{\circ}C < T_{amb} < +125^{\circ}C$	-	50	100 150	mV
CMRR	Common mode rejection ratio	$0 < V_{icm} < 2V$	-	67	-	dB
SVR	Supply voltage rejection	$\Delta V_{CC}= 2 \text{ to } 5V$	58	69	-	dB
$TP_{LH}$	Propagation delay Low to high output level	$V_{icm}=0V$ , $f=10kHz$ , $C_L=50pF$ , Overdrive = 20mV Overdrive = 100mV	-	39 33	75 60	ns
$TP_{HL}$	Propagation delay High to low output level	$V_{icm}=0V$ , $f=10kHz$ , $C_L=50pF$ , Overdrive = 20mV Overdrive = 100mV	-	39 33	75 60	ns
$T_F$	Fall time	$f=10kHz$ , $C_L=50pF$ , $R_L=10k\Omega$ , Overdrive = 100mV	-	8	-	ns
$T_R$	Rise time	$f=10kHz$ , $C_L=50pF$ , $R_L=10k\Omega$ , Overdrive = 100mV	-	9	-	ns

1. All values at non-ambient temperatures are guaranteed through correlation and simulation. No production test is performed at non-ambient temperatures.

2. Maximum values include unavoidable inaccuracies of the industrial test.

**Table 4.**  $V_{CC}=+3.3V$ ,  $T_{amb} = +25^{\circ}C$ , full  $V_{icm}$  range (unless otherwise specified)<sup>(1)</sup>

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{IO}$	Input offset voltage	$-40^{\circ}C < T_{amb} < +125^{\circ}C$	-	0.5	8 10	mV
$\Delta V_{IO}$	Input offset voltage drift	$-40^{\circ}C < T_{amb} < +125^{\circ}C$	-	3	20	$\mu V/^{\circ}C$
$I_{IO}$	Input offset current <sup>(2)</sup>	$-40^{\circ}C < T_{amb} < +125^{\circ}C$	-	1	20 100	nA
$I_{IB}$	Input bias current <sup>(2)</sup>	$-40^{\circ}C < T_{amb} < +125^{\circ}C$	-	80	160 300	nA
$I_{CC}$	Supply current	No load, output low, $V_{icm}=0V$ $-40^{\circ}C < T_{amb} < +125^{\circ}C$ No load, output high, $V_{icm}=0V$ $-40^{\circ}C < T_{amb} < +125^{\circ}C$	-	77 65	110 90 120 125	$\mu A$
$I_{SC}$	Short circuit current	Source Sink	-	33 28	-	mA
$V_{OH}$	Output voltage high	$I_{source}=1mA$ $-40^{\circ}C < T_{amb} < +125^{\circ}C$	3.20 3.10	3.26	-	V
$V_{OL}$	Output voltage low	$I_{source}=1mA$ $-40^{\circ}C < T_{amb} < +125^{\circ}C$	-	30	80 150	mV
CMRR	Common mode rejection ratio	$0 < V_{icm} < 3.3V$	-	71	-	dB
SVR	Supply voltage rejection	$\Delta V_{CC}= 2 \text{ to } 5V$	58	69	-	dB
$TP_{LH}$	Propagation delay Low to high output level	$V_{icm}=0V$ , $f=10kHz$ , $C_L=50pF$ , Overdrive = 20mV Overdrive = 100mV	-	42 34	85 65	ns
$TP_{HL}$	Propagation delay High to low output level	$V_{icm}=0V$ , $f=10kHz$ , $C_L=50pF$ , Overdrive = 20mV Overdrive = 100mV	-	41 34	80 65	ns
$T_F$	Fall time	$f=10kHz$ , $C_L=50pF$ , $R_L=10k\Omega$ , Overdrive = 100mV	-	5	-	ns
$T_R$	Rise time	$f=10kHz$ , $C_L=50pF$ , $R_L=10k\Omega$ , Overdrive = 100mV	-	7	-	ns

1. All values at non-ambient temperatures are guaranteed through correlation and simulation. No production test is performed at non-ambient temperatures.

2. Maximum values include unavoidable inaccuracies of the industrial test.

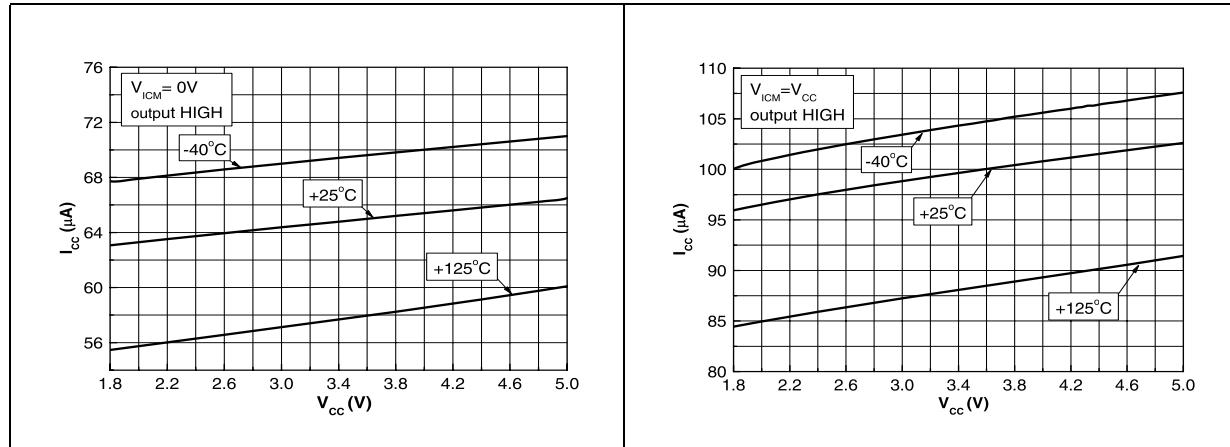
**Table 5.**  $V_{CC}=+5V$ ,  $T_{amb} = +25^{\circ}C$ , full  $V_{icm}$  range (unless otherwise specified)<sup>(1)</sup>

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{IO}$	Input offset voltage	$-40^{\circ}C < T_{amb} < +125^{\circ}C$	-	0.5	8 10	mV
$\Delta V_{IO}$	Input offset voltage drift	$-40^{\circ}C < T_{amb} < +125^{\circ}C$	-	3	20	$\mu V/^{\circ}C$
$I_{IO}$	Input offset current <sup>(2)</sup>	$-40^{\circ}C < T_{amb} < +125^{\circ}C$	-	1	20 100	nA
$I_{IB}$	Input bias current <sup>(2)</sup>	$-40^{\circ}C < T_{amb} < +125^{\circ}C$	-	80	160 300	nA
$I_{CC}$	Supply current	No load, output low, $V_{icm}=0V$ $-40^{\circ}C < T_{amb} < +125^{\circ}C$ No load, output high, $V_{icm}=0V$ $-40^{\circ}C < T_{amb} < +125^{\circ}C$	-	80 67	115 95 125 135	$\mu A$
$I_{SC}$	Short circuit current	Source Sink		62 47	-	mA
$V_{OH}$	Output voltage high	$I_{source}=4mA$ $-40^{\circ}C < T_{amb} < +125^{\circ}C$	4.80 4.70	4.87	-	V
$V_{OL}$	Output voltage low	$I_{source}=4mA$ $-40^{\circ}C < T_{amb} < +125^{\circ}C$	-	110	180 250	mV
CMRR	Common mode rejection ratio	$0 < V_{icm} < 5V$	-	72	-	dB
SVR	Supply voltage rejection	$\Delta V_{CC}=2$ to $5V$	58	69	-	dB
$TP_{LH}$	Propagation delay Low to high output level	$V_{icm}=0V$ , $f=10kHz$ , $C_L=50pF$ , Overdrive = 20mV Overdrive = 100mV	-	48 38	105 75	ns
$TP_{HL}$	Propagation delay High to low output level	$V_{icm}=0V$ , $f=10kHz$ , $C_L=50pF$ , Overdrive = 20mV Overdrive = 100mV	-	46 38	95 75	ns
$T_F$	Fall time	$f=10kHz$ , $C_L=50pF$ , $R_L=10k\Omega$ Overdrive = 100mV	-	4	-	ns
$T_R$	Rise time	$f=10kHz$ , $C_L=50pF$ , $R_L=10k\Omega$ Overdrive = 100mV	-	4	-	ns

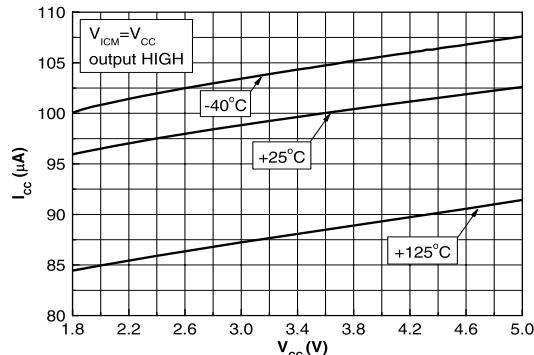
1. All values at non-ambient temperatures are guaranteed through correlation and simulation. No production test is performed at non-ambient temperatures.

2. Maximum values include unavoidable inaccuracies of the industrial test.

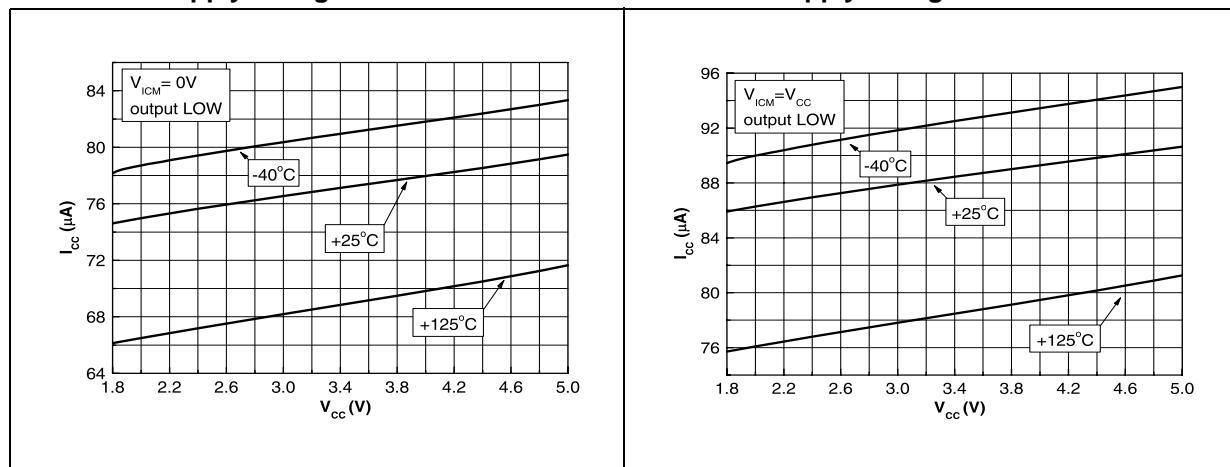
**Figure 1. Current consumption vs. power supply voltage**



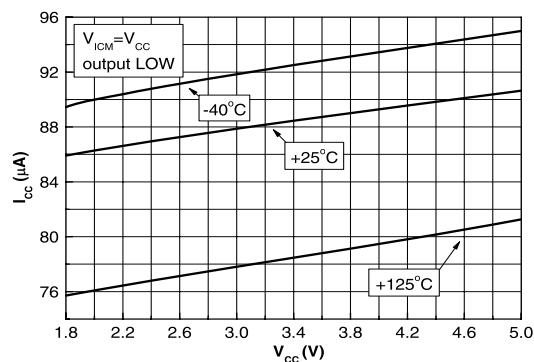
**Figure 2. Current consumption vs. power supply voltage**



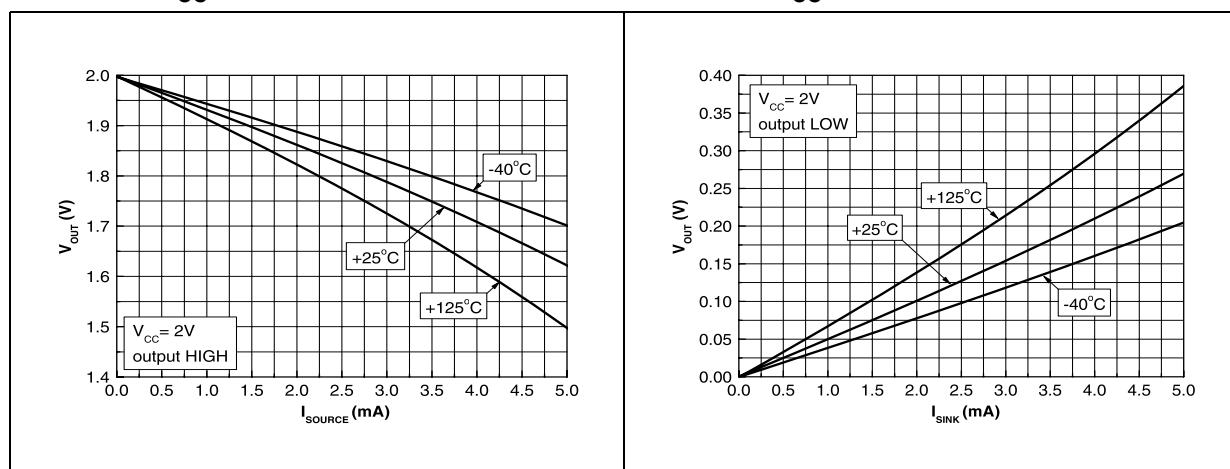
**Figure 3. Current consumption vs. power supply voltage**



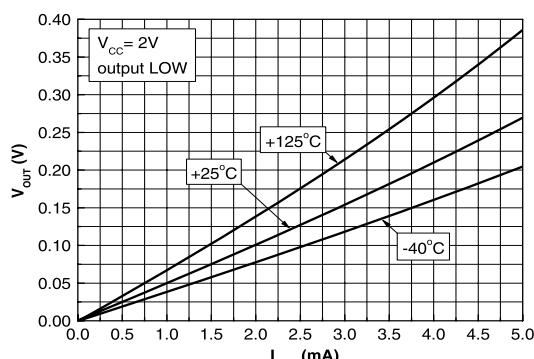
**Figure 4. Current consumption vs. power supply voltage**



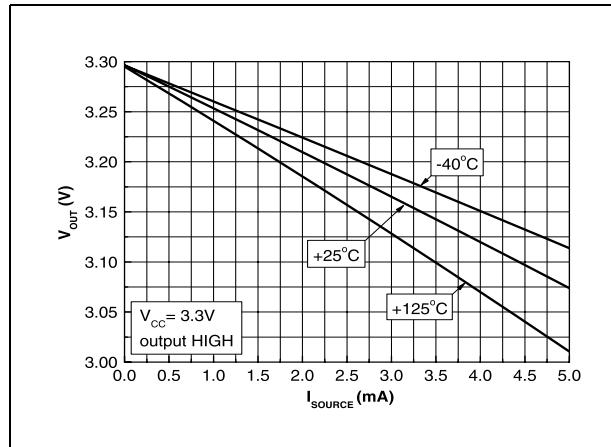
**Figure 5. Output voltage vs. source current  $V_{CC}=2V$**



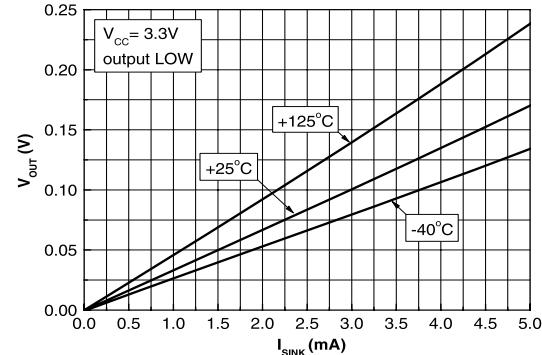
**Figure 6. Output voltage vs. sink current  $V_{CC}=2V$**



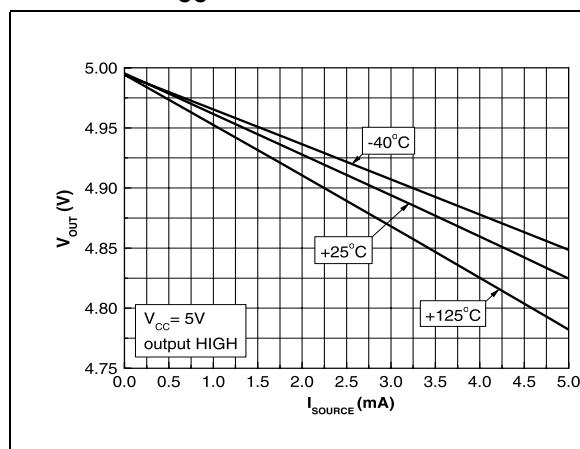
**Figure 7. Output voltage vs. source current  
 $V_{CC}=3.3V$**



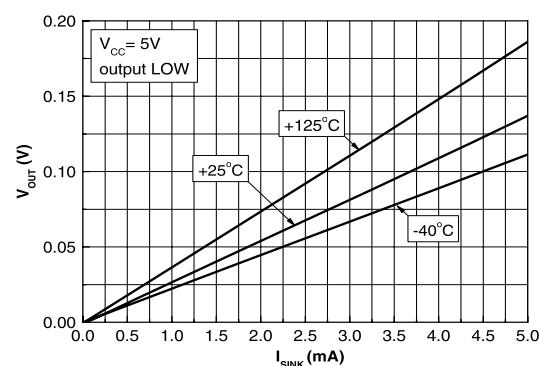
**Figure 8. Output voltage vs. sink current  
 $V_{CC}=3.3V$**



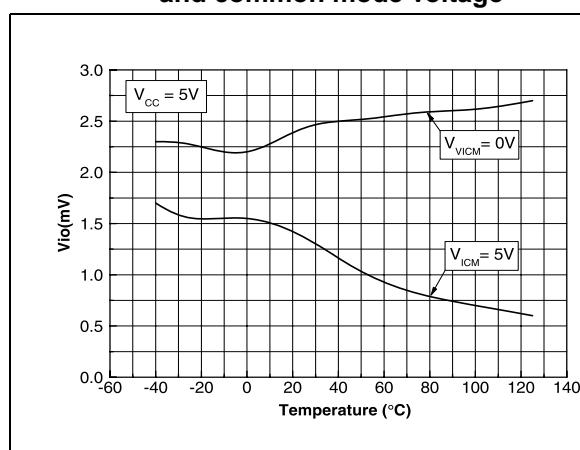
**Figure 9. Output Voltage vs. source current  
 $V_{CC}=5V$**



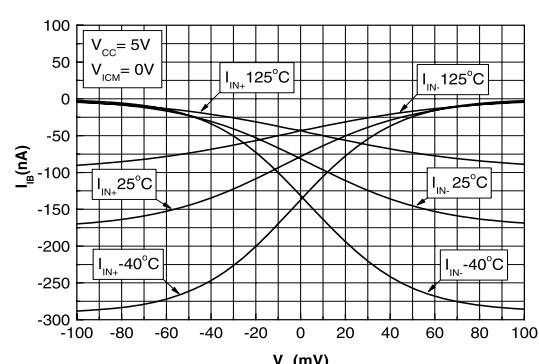
**Figure 10. Output voltage vs. sink current  
 $V_{CC}=5V$**



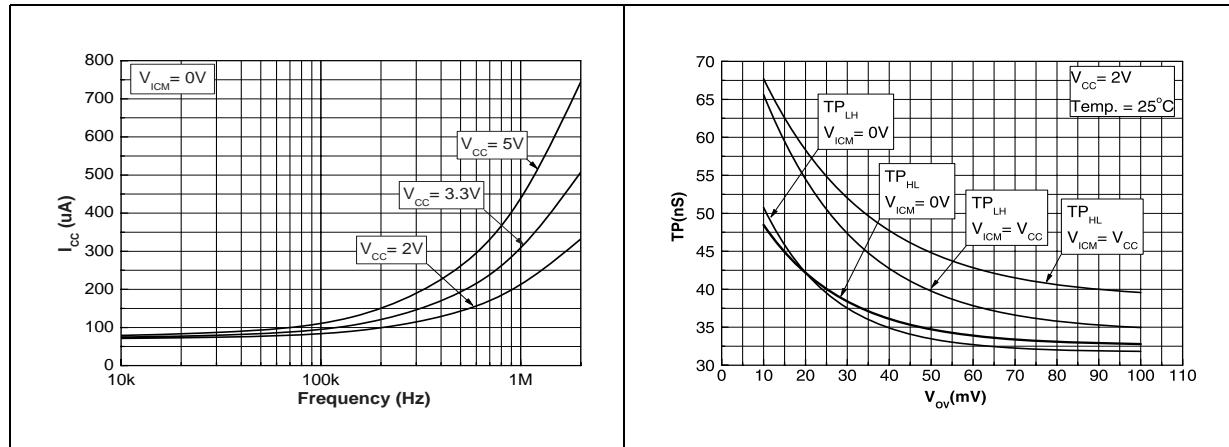
**Figure 11. Input offset voltage vs. temperature and common mode voltage**



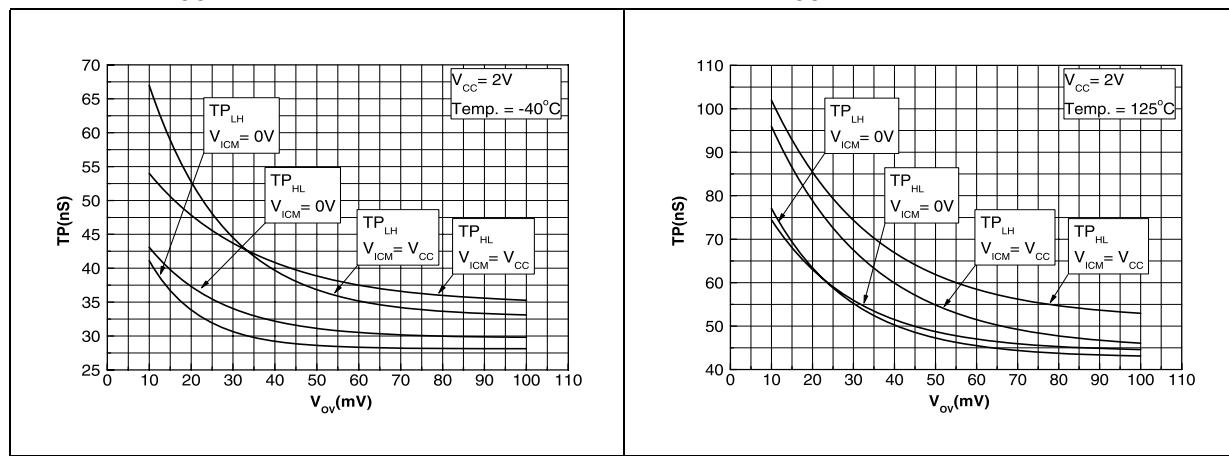
**Figure 12. Input bias current vs. temperature and input voltage**



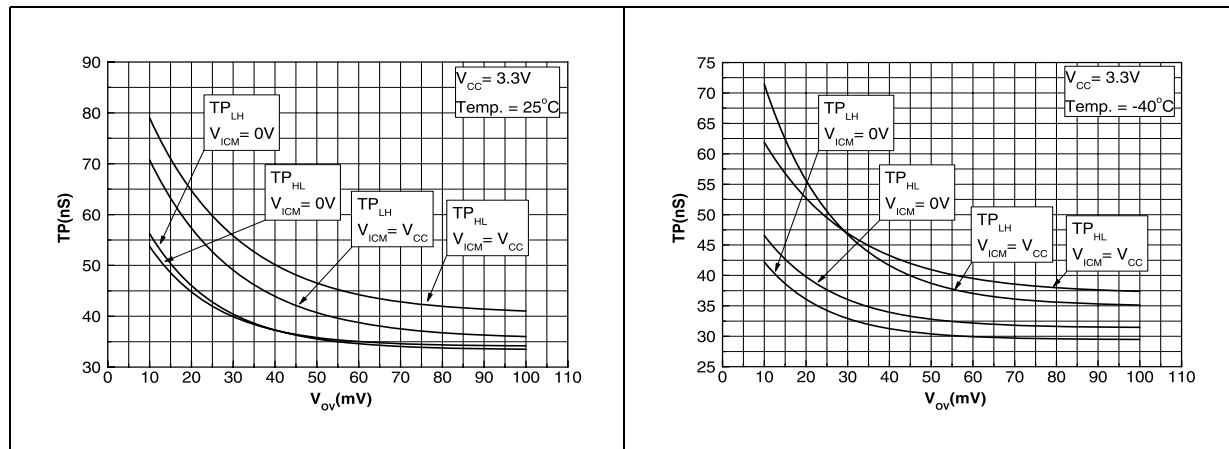
**Figure 13. Current consumption vs. commutation frequency**



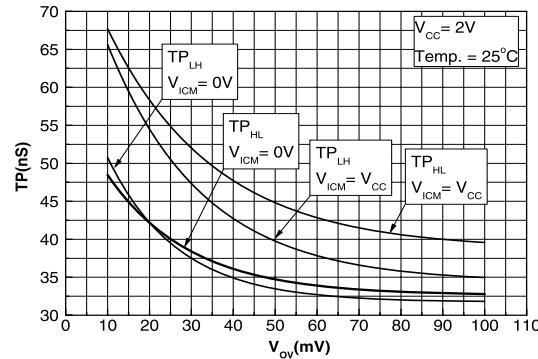
**Figure 15. Propagation delay vs. overdrive V<sub>CC</sub>=2V**



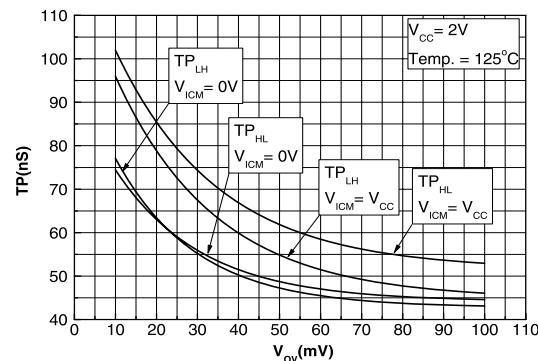
**Figure 17. Propagation delay vs. overdrive V<sub>CC</sub>=3.3V**



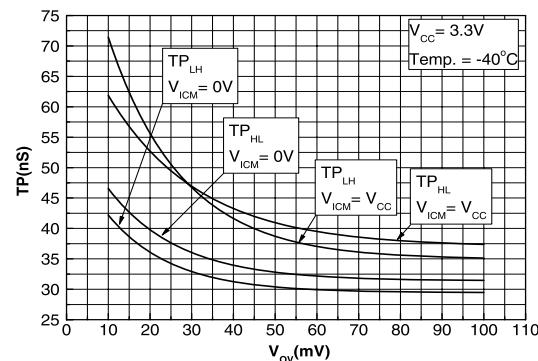
**Figure 14. Propagation delay vs. overdrive V<sub>CC</sub>=2V**



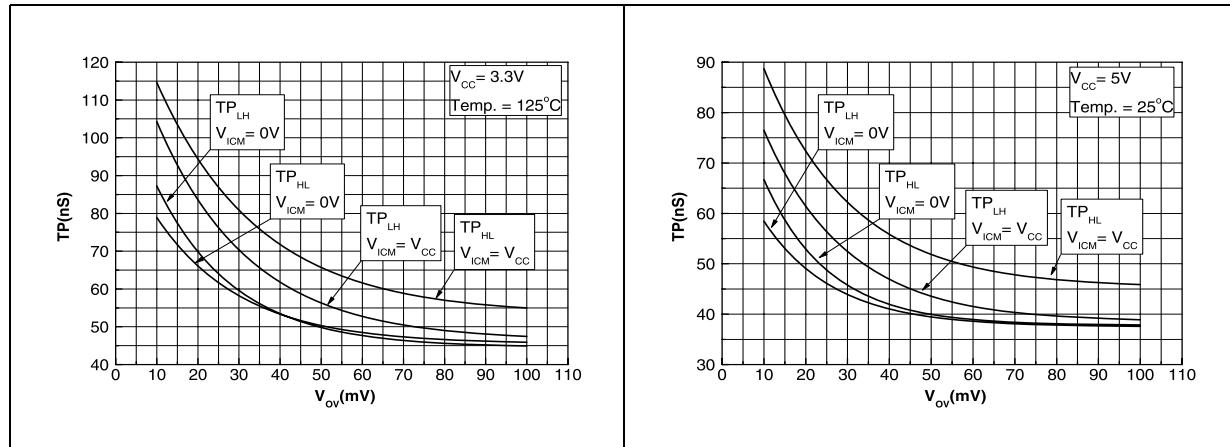
**Figure 16. Propagation delay vs. overdrive V<sub>CC</sub>=2V**



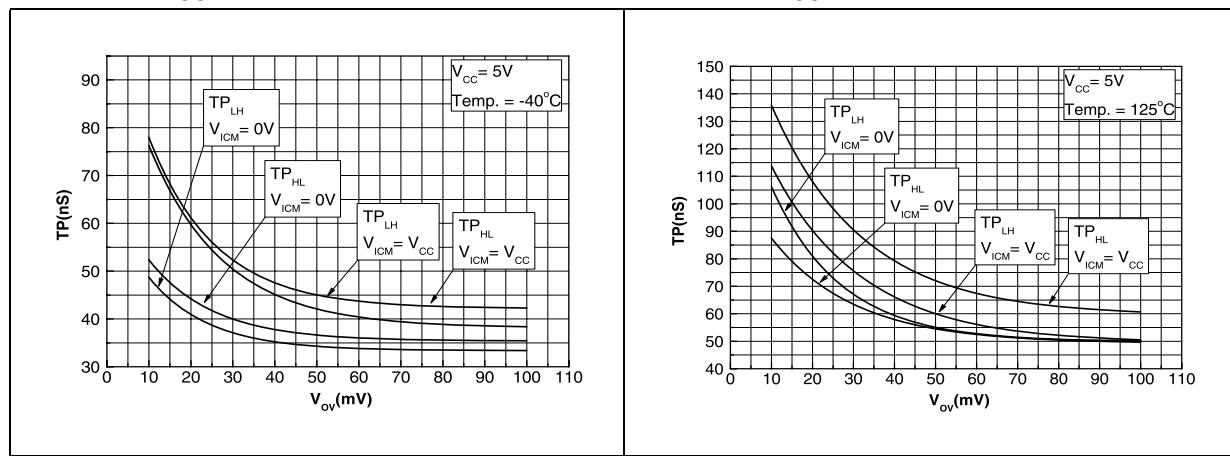
**Figure 18. Propagation delay vs. overdrive V<sub>CC</sub>=3.3V**



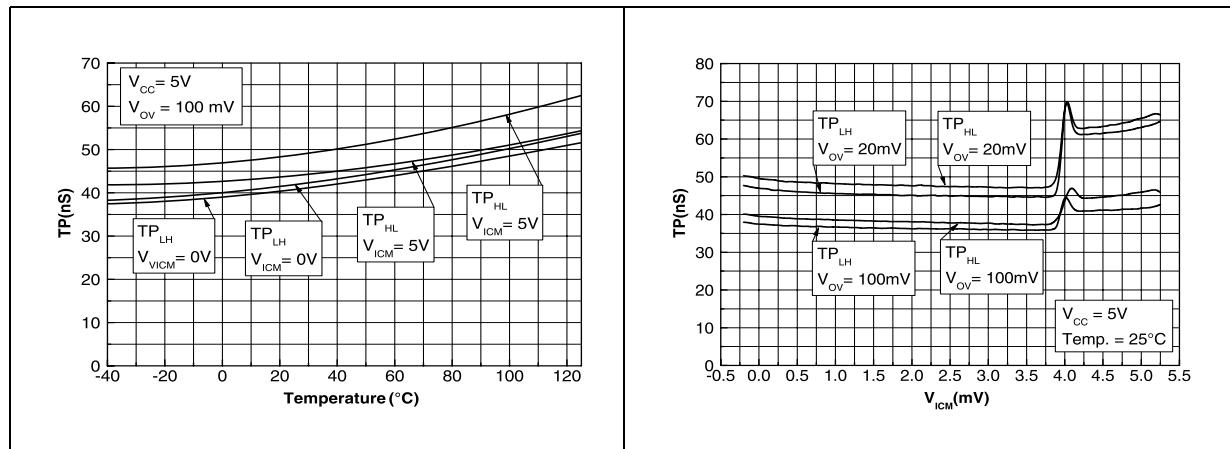
**Figure 19. Propagation delay vs. overdrive  
 $V_{CC}=3.3V$**



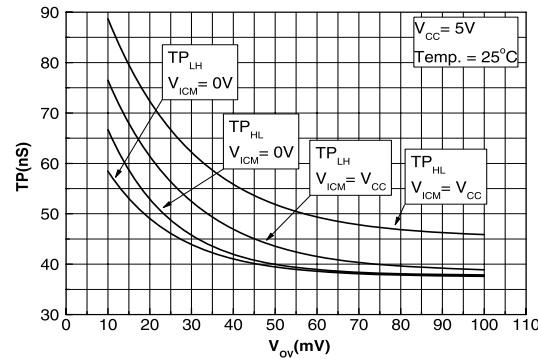
**Figure 21. Propagation delay vs. overdrive  
 $V_{CC}=5V$**



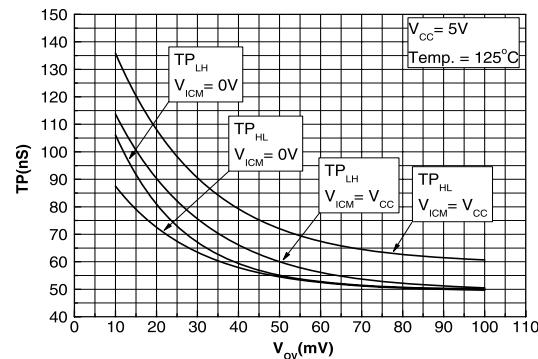
**Figure 23. Propagation delay vs. temperature  
 $V_{CC}=5V$ , overdrive=100mV**



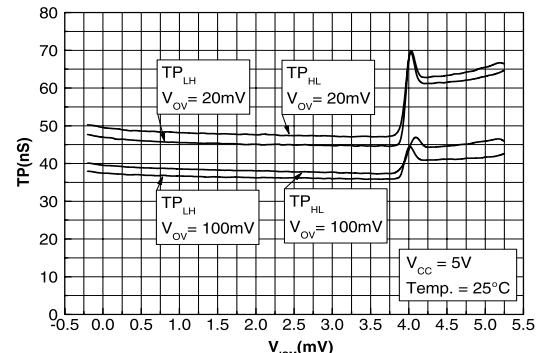
**Figure 20. Propagation delay vs. overdrive  
 $V_{CC}=5V$**



**Figure 22. Propagation delay vs. overdrive  
 $V_{CC}=5V$**



**Figure 24. Propagation delay vs. common mode voltage,  $V_{CC}=5V$**

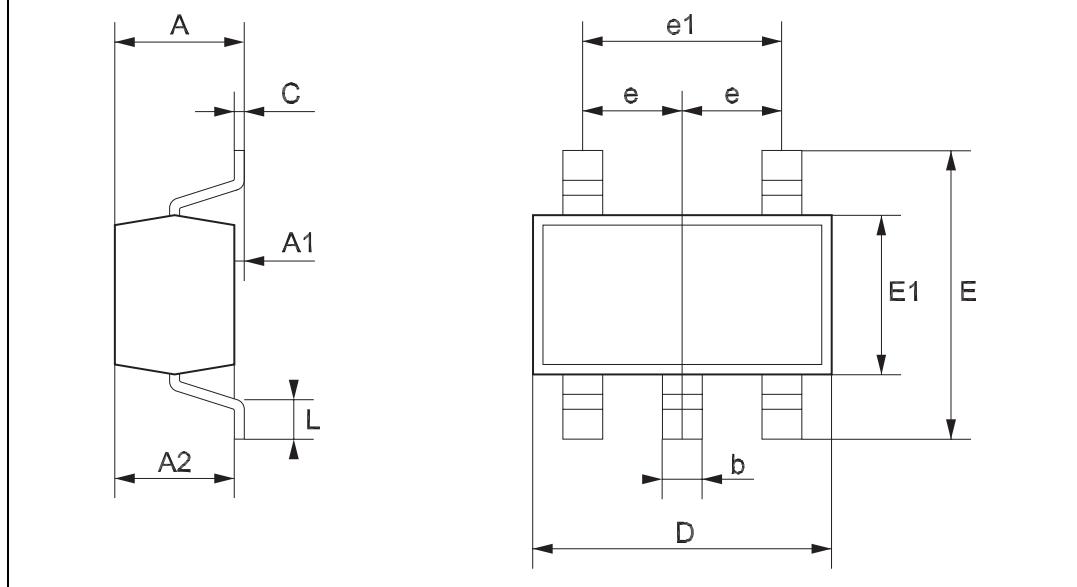


### 3 Package information

In order to meet environmental requirements, STMicroelectronics offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an STMicroelectronics trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com).

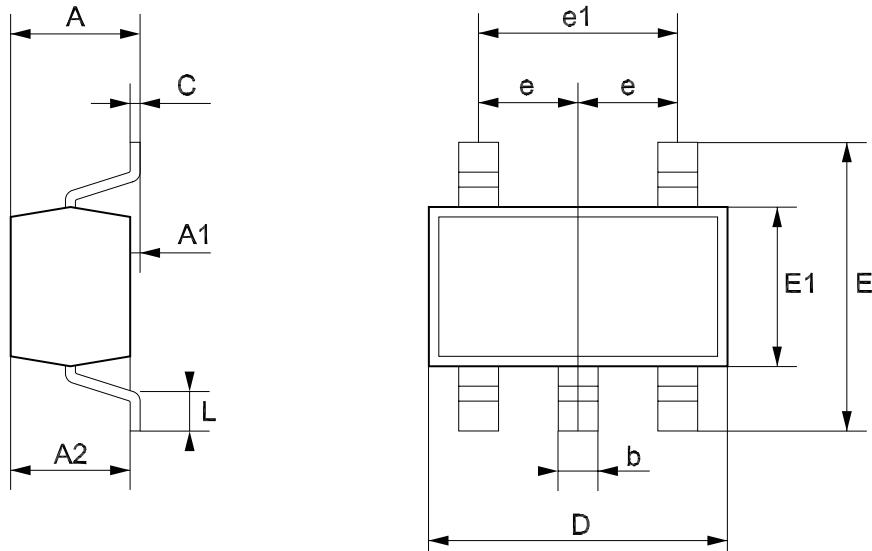
### 3.1 SOT23-5 package mechanical data

Ref.	Dimensions					
	Millimeters			Mils		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.90		1.45	35.4		57.1
A1	0.00		0.15	0.00		5.9
A2	0.90		1.30	35.4		51.2
b	0.35		0.50	13.7		19.7
C	0.09		0.20	3.5		7.8
D	2.80		3.00	110.2		118.1
E	2.60		3.00	102.3		118.1
E1	1.50		1.75	59.0		68.8
e		0.95			37.4	
e1		1.9			74.8	
L	0.35		0.55	13.7		21.6



### 3.2 SC70-5 (SOT323-5) package mechanical data

Ref	Dimensions					
	Millimeters			Mils		
	Min	Typ	Max	Min	Typ	Max
<b>A</b>	0.80		1.10	31.5		43.3
<b>A1</b>	0.00		0.10	0.0		3.9
<b>A2</b>	0.80		1.00	31.5		39.4
<b>b</b>	0.15		0.30	5.9		11.8
<b>C</b>	0.10		0.18	3.9		7.1
<b>D</b>	1.80		2.20	70.9		86.6
<b>E</b>	1.80		2.40	70.9		94.5
<b>E1</b>	1.15		1.35	45.3		53.1
<b>e</b>		0.65			25.6	
<b>e1</b>		1.3			51.2	
<b>L</b>	0.10		0.30	3.9		11.8



### 3.3 SO8 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	1.35		1.75	0.053		0.069
A1	0.10		0.25	0.04		0.010
A2	1.10		1.65	0.043		0.065
B	0.33		0.51	0.013		0.020
C	0.19		0.25	0.007		0.010
D	4.80		5.00	0.189		0.197
E	3.80		4.00	0.150		0.157
e		1.27			0.050	
H	5.80		6.20	0.228		0.244
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k	8° (max.)					
ddd			0.1			0.04

The diagram illustrates the mechanical dimensions of the SO8 package. The top-left drawing shows the side profile with dimensions D, A, A1, B, and A2. The top-right drawing shows the end profile with a 45-degree lead angle (Hx45°) and height C. The bottom-left drawing shows the top view with pin numbers 1 through 8, lead pitch e, and height H. The bottom-right drawing provides a detailed view of the seating plane, indicating a 0.25 mm gage plane, the seating plane itself, lead length L, and the lead angle k.

### 3.4 MiniSO8 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.1			0.043
A1	0.05	0.10	0.15	0.002	0.004	0.006
A2	0.78	0.86	0.94	0.031	0.034	0.037
b	0.25	0.33	0.40	0.010	0.013	0.016
c	0.13	0.18	0.23	0.005	0.007	0.009
D	2.90	3.00	3.10	0.114	0.118	0.122
E	4.75	4.90	5.05	0.187	0.193	0.199
E1	2.90	3.00	3.10	0.114	0.118	0.122
e		0.65			0.026	
K	0°		6°	0°		6°
L	0.40	0.55	0.70	0.016	0.022	0.028
L1			0.10			0.004

The figure contains three detailed mechanical drawings of the MiniSO8 package:

- Top View:** Shows the package in a rectangular footprint with pins labeled 1 through 8. Pin 1 is identified by a dot at the bottom center. The width is labeled E, and the height is labeled D. A callout shows the seating plane and a gage plane offset of 0.25 mm or .010 inch.
- Side View:** Shows the package thickness (A) and lead spacing (L). It also indicates lead kink relief (K) and lead height (L1).
- Pin Layout:** Shows the pin configuration with pins 1 through 8 around the perimeter. Pin 1 is at the bottom, followed by 8, 5, 4, 2, 3, 6, and 7 at the top.

## 4 Ordering information

Table 6. Order codes

Part number	Temperature range	Package	Packaging	Marking
TS3021ILT	-40°C, +125°C	SOT23-5	Tape & reel	K520
TS3021ICT		SC70-5	Tape & reel	K52
TS3022ID		SO8	Tube	TS3022I
TS3022IDT		SO8	Tape & reel	TS3022I
TS3022IST		MiniSO8	Tape & reel	K521

## 5 Revision history

Date	Revision	Changes
1-Jun-2006	1	Initial release.
1-Sep-2006	2	Dual version added. Pin-out of single TS3021 corrected. Modified temperature range for input common mode voltage.
22-Feb-2007	3	Addition of MiniSO8 package for dual version.

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